

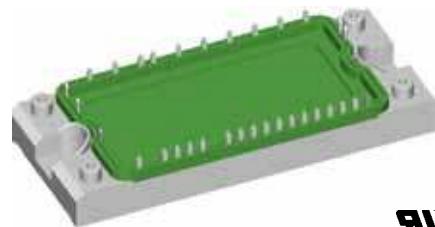
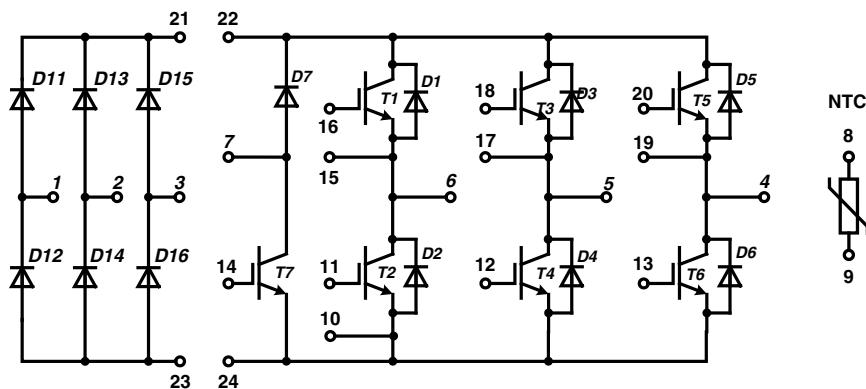
# Converter - Brake - Inverter Module

## XPT IGBT

Three Phase Rectifier	Brake Chopper	Three Phase Inverter
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 1200 \text{ V}$	$V_{CES} = 1200 \text{ V}$
$I_{DAVM} = 105 \text{ A}$	$I_{C25} = 17 \text{ A}$	$I_{C25} = 43 \text{ A}$
$I_{FSM} = 320 \text{ A}$	$V_{CE(sat)} = 1.8 \text{ V}$	$V_{CE(sat)} = 1.8 \text{ V}$

**Part name** (Marking on product)

MIXA30WB1200TED



E 72873

Pin configuration see outlines.

### Features:

- Easy paralleling due to the positive temperature coefficient of the on-state voltage
- Rugged XPT design  
(Xtreme light Punch Through) results in:
  - short circuit rated for 10  $\mu\text{sec}$ .
  - very low gate charge
  - low EMI
- Thin wafer technology combined with the XPT design results in a competitive low  $V_{CE(sat)}$
- SONIC™ diode
  - fast and soft reverse recovery
  - low operating forward voltage

### Application:

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies

### Package:

- "E2-Pack" standard outline
- Insulated copper base plate
- Soldering pins for PCB mounting
- Temperature sense included

## Output Inverter T1 - T6

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{CES}$	collector emitter voltage	$T_{VJ} = 25^\circ C$		1200		V
$V_{GES}$	max. DC gate voltage	continuous		$\pm 20$		V
$V_{GEM}$	max. transient collector gate voltage	transient		$\pm 30$		V
$I_{C25}$	collector current	$T_C = 25^\circ C$		43		A
$I_{C80}$		$T_C = 80^\circ C$		30		A
$P_{tot}$	total power dissipation	$T_C = 25^\circ C$		150		W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 25 A; V_{GE} = 15 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	1.8 2.1	2.1	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 1 mA; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ C$	5.4	6.0	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	0.02 0.2	1.5	mA mA
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20 V$		500		nA
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 V; V_{GE} = 15 V; I_C = 25 A$		76		nC
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$ $E_{on}$ $E_{off}$	turn-on delay time current rise time turn-off delay time current fall time turn-on energy per pulse turn-off energy per pulse	inductive load $V_{CE} = 600 V; I_C = 15 A$ $V_{GE} = \pm 15 V; R_G = 39 \Omega$	$T_{VJ} = 125^\circ C$	70 40 250 100 2.5 3.0		ns ns ns ns mJ mJ
RBSOA	reverse bias safe operating area	$V_{GE} = \pm 15 V; R_G = 39 \Omega;$	$T_{VJ} = 125^\circ C$ $V_{CEK} = 1200 V$		75	A
SCSOA	short circuit safe operating area					
$t_{sc}$ $I_{sc}$	short circuit duration short circuit current	$V_{CE} = 900 V; V_{GE} = \pm 15 V;$ $R_G = 39 \Omega$ ; non-repetitive	$T_{VJ} = 125^\circ C$	100	10	$\mu s$ A
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			0.84	K/W

## Output Inverter D1 - D6

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 25^\circ C$		1200		V
$I_{F25}$	forward current	$T_C = 25^\circ C$		44		A
$I_{F80}$		$T_C = 80^\circ C$		30		A
$V_F$	forward voltage	$I_F = 30 A; V_{GE} = 0 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	1.95 1.95	2.2	V V
$Q_{rr}$ $I_{RM}$ $t_{rr}$ $E_{rec}$	reverse recovery charge max. reverse recovery current reverse recovery time reverse recovery energy	$V_R = 600 V$ $di_F/dt = -600 A/\mu s$ $I_F = 30 A; V_{GE} = 0 V$	$T_{VJ} = 125^\circ C$	3.5 30 350 0.9		$\mu C$ A ns mJ
$R_{thJC}$	thermal resistance junction to case	(per diode)			1.2	K/W

 $T_C = 25^\circ C$  unless otherwise stated

## Brake T7

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{CES}$	collector emitter voltage	$T_{VJ} = 25^\circ C$		1200		V
$V_{GES}$	max. DC gate voltage	continuous		$\pm 20$		V
$V_{GEM}$	max. transient collector gate voltage	transient		$\pm 30$		V
$I_{C25}$	collector current	$T_C = 25^\circ C$	17		A	
$I_{C80}$		$T_C = 80^\circ C$	12		A	
$P_{tot}$	total power dissipation	$T_C = 25^\circ C$	60		W	
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 9 A; V_{GE} = 15 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	1.8 2.1	2.1	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.3 mA; V_{GE} = V_{CE}$	$T_{VJ} = 25^\circ C$	5.4	6.0	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		0.1	mA
$I_{GES}$	gate emitter leakage current	$V_{GE} = \pm 20 V$			500	nA
$Q_{G(on)}$	total gate charge	$V_{CE} = 600 V; V_{GE} = 15 V; I_C = 10 A$	28		nC	
$t_{d(on)}$	turn-on delay time	<div style="border-left: 1px solid black; padding-left: 10px;">inductive load <math>V_{CE} = 600 V; I_C = 10 A</math> <math>V_{GE} = \pm 15 V; R_G = 100 \Omega</math></div>	70			ns
$t_r$	current rise time		40			ns
$t_{d(off)}$	turn-off delay time		250			ns
$t_f$	current fall time		100			ns
$E_{on}$	turn-on energy per pulse		1.1			mJ
$E_{off}$	turn-off energy per pulse		1.1			mJ
<b>RBSOA</b>	reverse bias safe operating area	$V_{GE} = \pm 15 V; R_G = 100 \Omega;$ $V_{CEK} = 1200 V$		30		A
<b>SCSOA</b>	short circuit safe operating area					
$t_{sc}$	short circuit duration	$V_{CE} = 900 V; V_{GE} = \pm 15 V;$			10	$\mu s$
$I_{sc}$	short circuit current	$R_G = 100 \Omega$ ; non-repetitive		40		A
$R_{thJC}$	thermal resistance junction to case	(per IGBT)			2.0	K/W

## Brake Chopper D7

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 25^\circ C$		1200		V
$I_{F25}$	forward current	$T_C = 25^\circ C$	12		A	
$I_{F80}$		$T_C = 80^\circ C$	8		A	
$V_F$	forward voltage	$I_F = 5 A; V_{GE} = 0 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	1.95 1.95	2.2	V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	0.5	0.5	mA
$Q_{rr}$	reverse recovery charge	<div style="border-left: 1px solid black; padding-left: 10px;"><math>V_R = 600 V</math> <math>di_F/dt = 200 A/\mu s</math> <math>I_F = 5 A; V_{GE} = 0 V</math></div>	0.6			$\mu C$
$I_{RM}$	max. reverse recovery current		6			A
$t_{rr}$	reverse recovery time		350			ns
$E_{rec}$	reverse recovery energy		0.2			mJ
$R_{thJC}$	thermal resistance junction to case	(per diode)			3.4	K/W

 $T_C = 25^\circ C$  unless otherwise stated

**Input Rectifier Bridge D11 - D16**

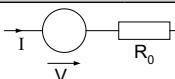
<b>Ratings</b>						
<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
$V_{RRM}$	max. repetitive reverse voltage		$T_{VJ} = 25^\circ\text{C}$		1600	V
$I_{FAV}$	average forward current	sine 180°	$T_C = 80^\circ\text{C}$		37	A
$I_{DAVM}$	max. average DC output current	rect.; $d = 1/3$	$T_C = 80^\circ\text{C}$		105	A
$I_{FSM}$	max. forward surge current	$t = 10 \text{ ms}; \text{sine } 50 \text{ Hz}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		320 280	A A
$I^2t$	$I^2t$ value for fusing	$t = 10 \text{ ms}; \text{sine } 50 \text{ Hz}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$		510 390	A <sup>2</sup> s A <sup>2</sup> s
$P_{tot}$	total power dissipation		$T_C = 25^\circ\text{C}$		110	W
$V_F$	forward voltage	$I_F = 50 \text{ A}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	1.34 1.34	1.7	V V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	0.2	0.02	mA mA
$R_{thJC}$	thermal resistance junction to case	(per diode)			1.1	K/W

**Temperature Sensor NTC**

<b>Ratings</b>						
<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
$R_{25}$	resistance		$T_C = 25^\circ\text{C}$	4.75	5.0	kΩ
$B_{25/50}$					3375	K

**Module**

<b>Ratings</b>						
<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
$T_{VJ}$	operating temperature		-40		125	°C
$T_{VJM}$	max. virtual junction temperature				150	°C
$T_{stg}$	storage temperature		-40		125	°C
$V_{ISOL}$	isolation voltage	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz}$			2500	V~
$CTI$	comparative tracking index				-	
$M_d$	mounting torque (M5)		3		6	Nm
$d_s$	creep distance on surface		6			mm
$d_A$	strike distance through air		6			mm
$R_{pin-chip}$	resistance pin to chip				5	mΩ
$R_{thCH}$	thermal resistance case to heatsink	with heatsink compound		0.02		K/W
<b>Weight</b>					180	g

**Equivalent Circuits for Simulation**

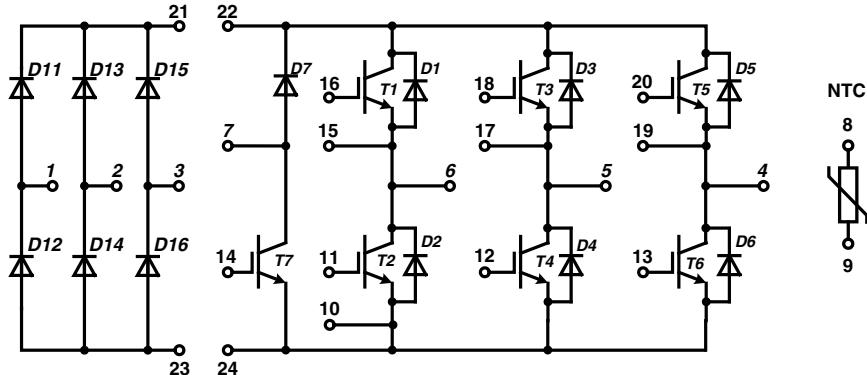
<b>Ratings</b>						
<b>Symbol</b>	<b>Definitions</b>	<b>Conditions</b>	<b>min.</b>	<b>typ.</b>	<b>max.</b>	<b>Unit</b>
$V_0$	rectifier diode	D8 - D13	$T_{VJ} = 150^\circ\text{C}$		0.88	V
$R_0$					9	mΩ
$V_0$	IGBT	T1 - T6	$T_{VJ} = 150^\circ\text{C}$		1.1	V
$R_0$					55	mΩ
$V_0$	free wheeling diode	D1 - D6	$T_{VJ} = 150^\circ\text{C}$		1.2	V
$R_0$					27	mΩ
$V_0$	IGBT	T7	$T_{VJ} = 150^\circ\text{C}$		1.1	V
$R_0$					153	mΩ
$V_0$	free wheeling diode	D7	$T_{VJ} = 150^\circ\text{C}$		1.15	V
$R_0$					170	mΩ

$T_C = 25^\circ\text{C}$  unless otherwise stated

IXYS reserves the right to change limits, test conditions and dimensions.

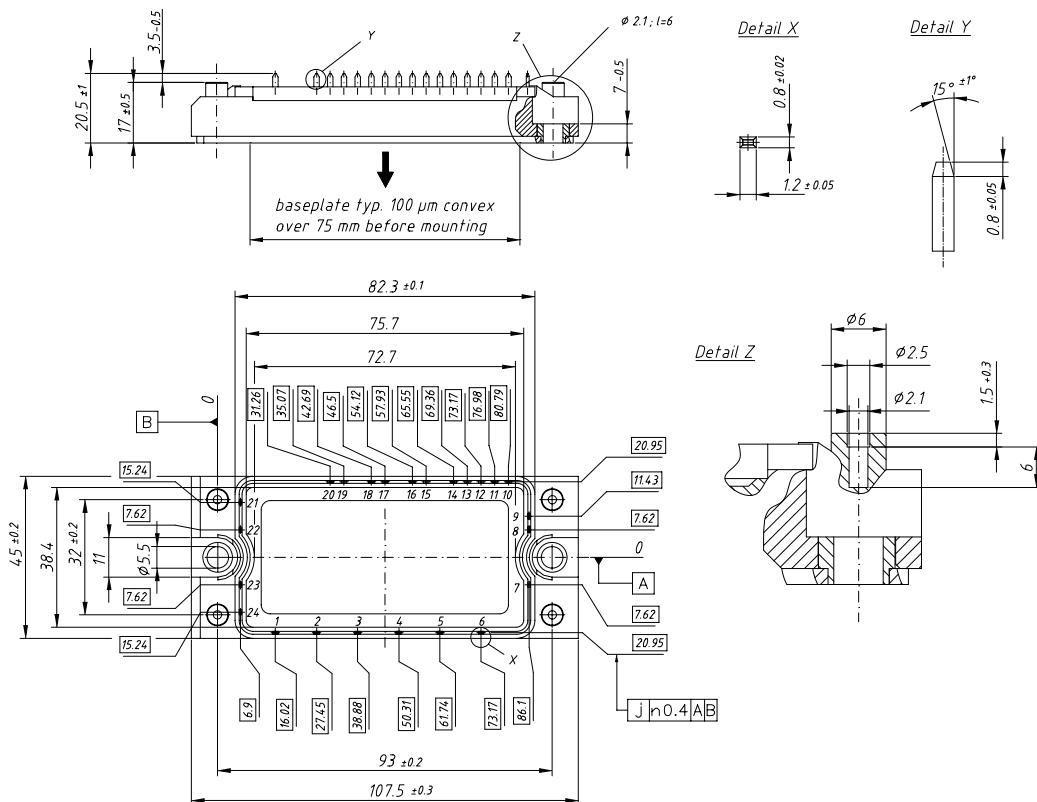
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## Circuit Diagram

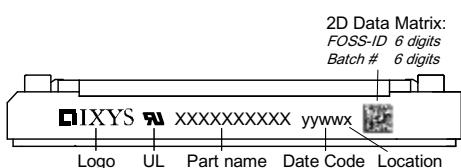


## Outline Drawing

Dimensions in mm (1 mm = 0.0394")



## Product Marking



2D Data Matrix:  
FOSS-ID 6 digits  
Batch # 6 digits

## Part number

M = Module  
I = IGBT  
X = XPT  
A = Standard  
30 = Current Rating [A]  
WB = 6-Pack + 3~ Rectifier Bridge & Brake Unit  
1200 = Reverse Voltage [V]  
T = NTC  
ED = E2-Pack

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	MIXA30WB1200 TED	MIXA30WB1200TED	Box	6	509 119

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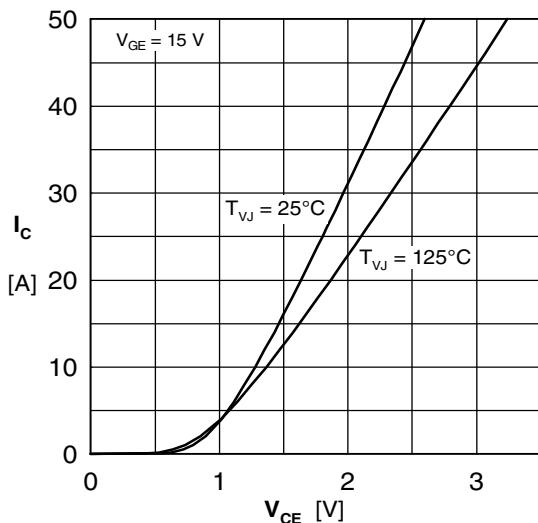
**Inverter T1 - T6**


Fig. 1 Typ. output characteristics

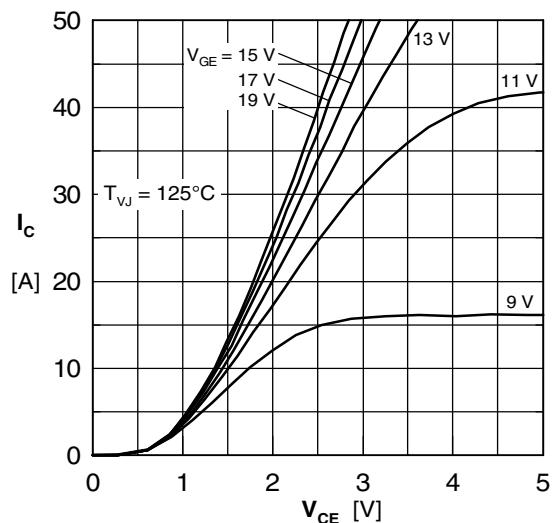


Fig. 2 Typ. output characteristics

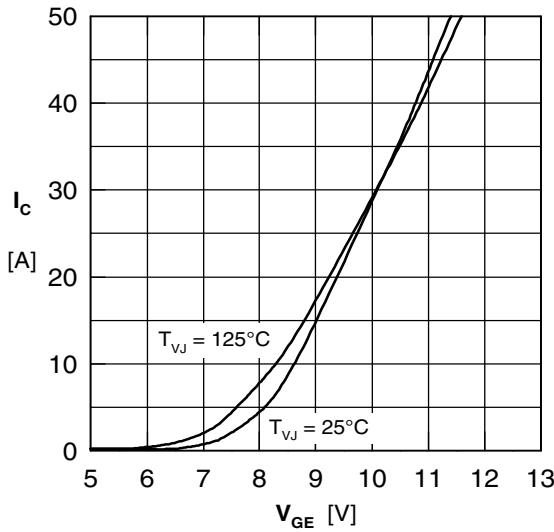


Fig. 3 Typ. tranfer characteristics

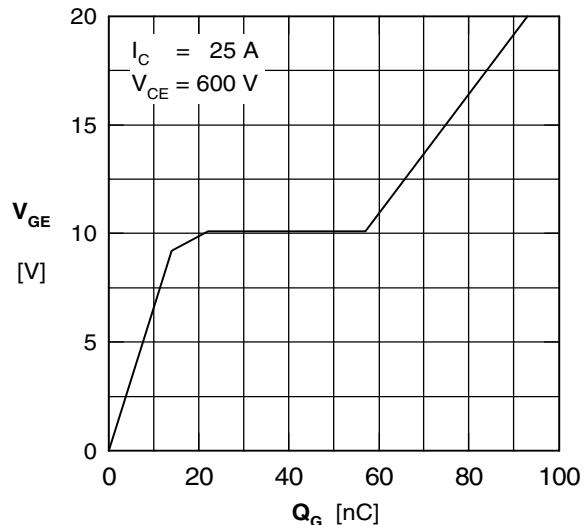


Fig. 4 Typ. turn-on gate charge

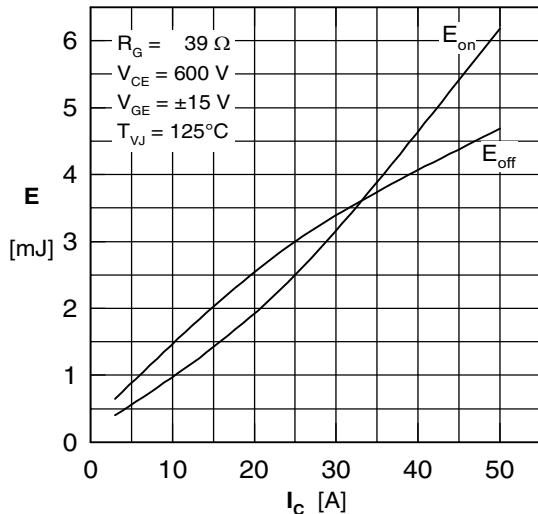


Fig. 5 Typ. switching energy vs. collector current

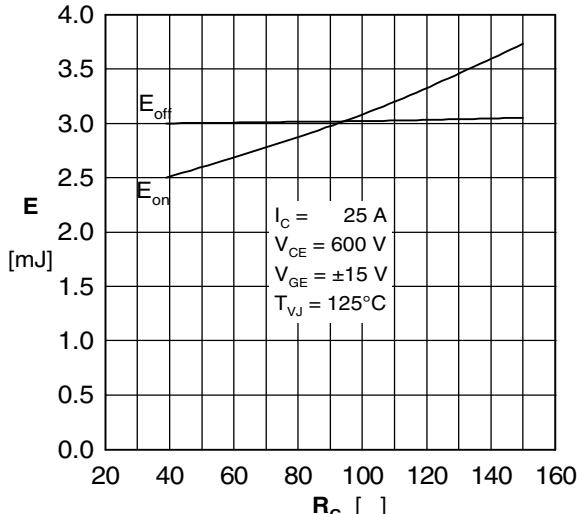


Fig. 6 Typ. switching energy vs. gate resistance

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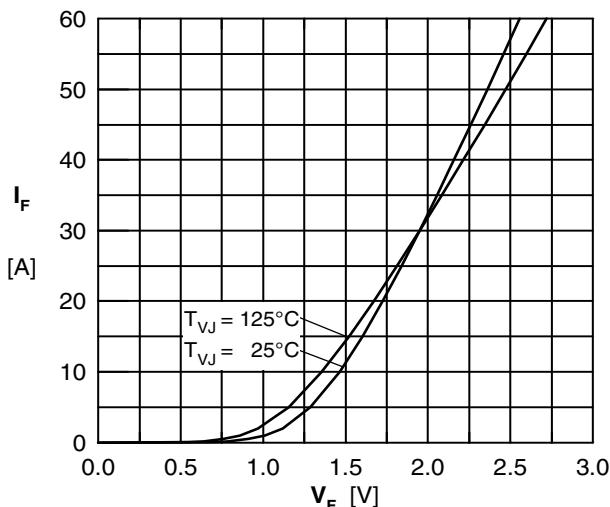
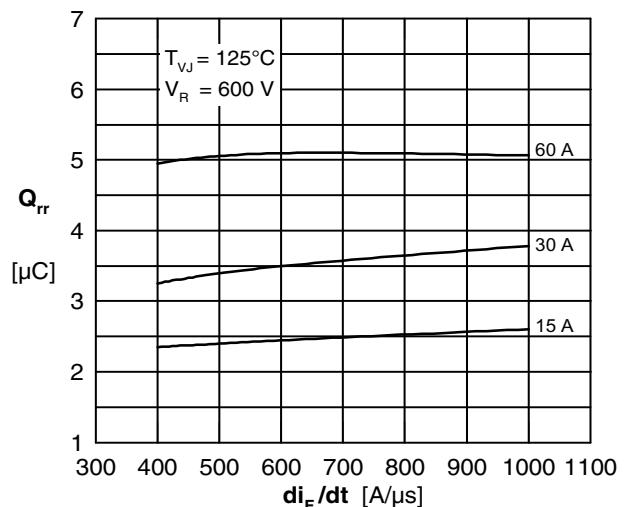
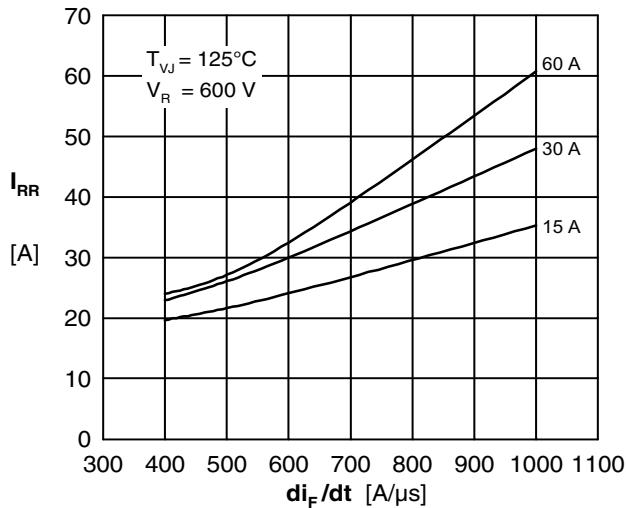
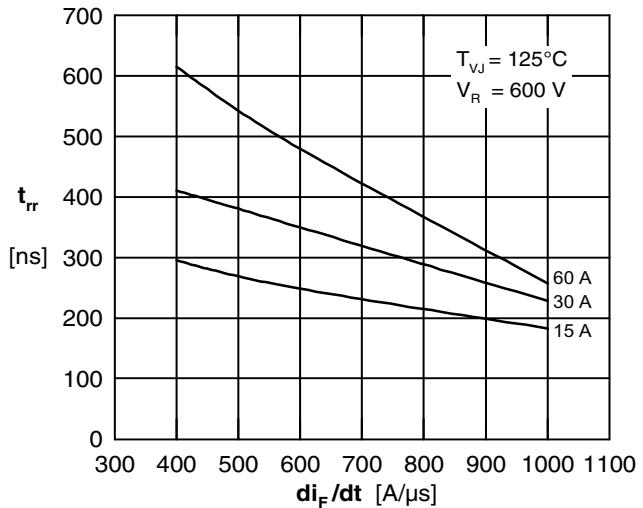
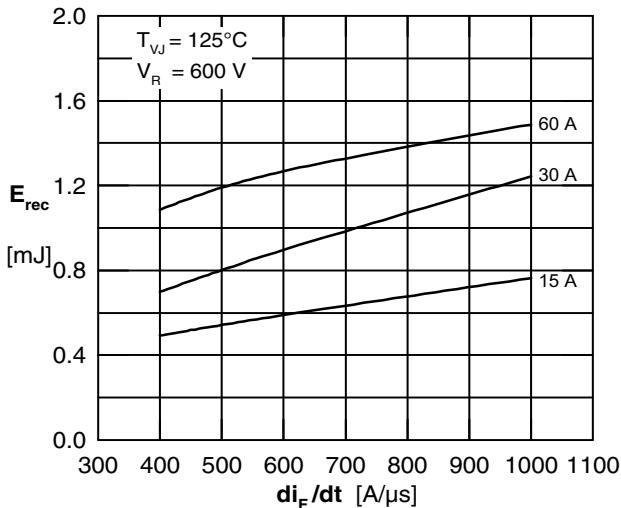
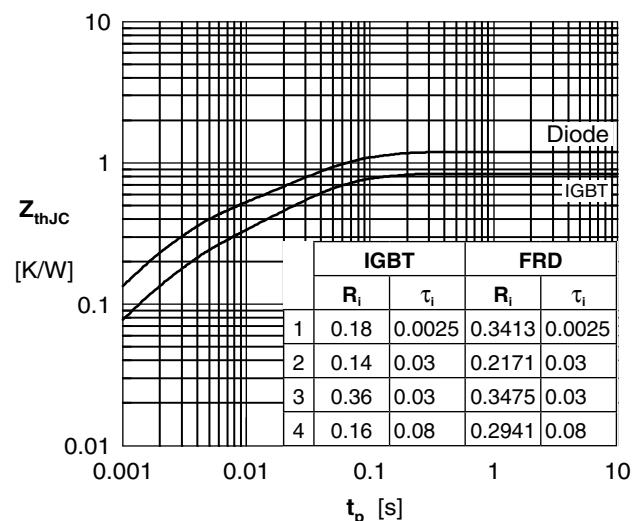
**Inverter D1 - D6**

 Fig. 7 Typ. Forward current versus  $V_F$ 

 Fig. 8 Typ. reverse recov.charge  $Q_{rr}$  vs.  $di/dt$ 

 Fig. 9 Typ. peak reverse current  $I_{rrm}$  vs.  $di/dt$ 

 Fig. 10 Typ. recovery time  $t_{rr}$  versus  $di/dt$ 

 Fig. 11 Typ. recovery energy  $E_{rec}$  versus  $di/dt$ 


Fig. 12 Typ. transient thermal impedance

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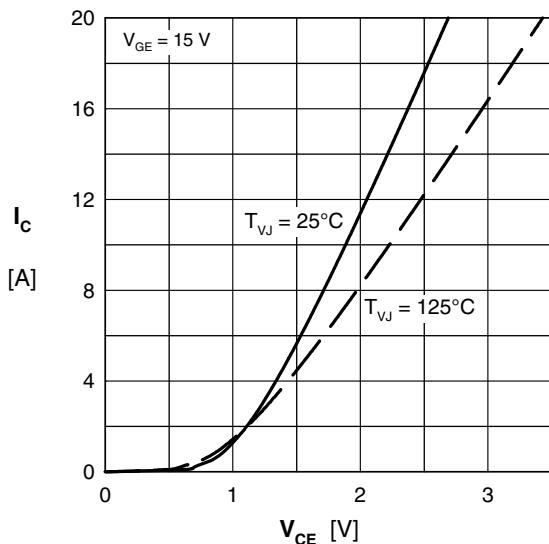
**Brake T7 & D7**


Fig. 13 Typ. output characteristics

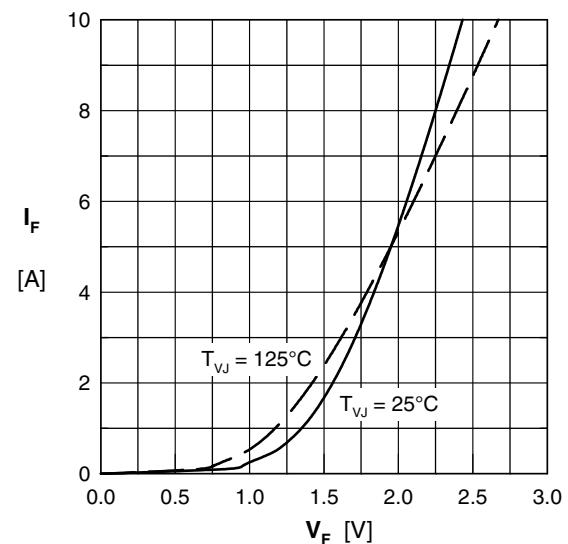


Fig. 14 Typ. forward characteristics

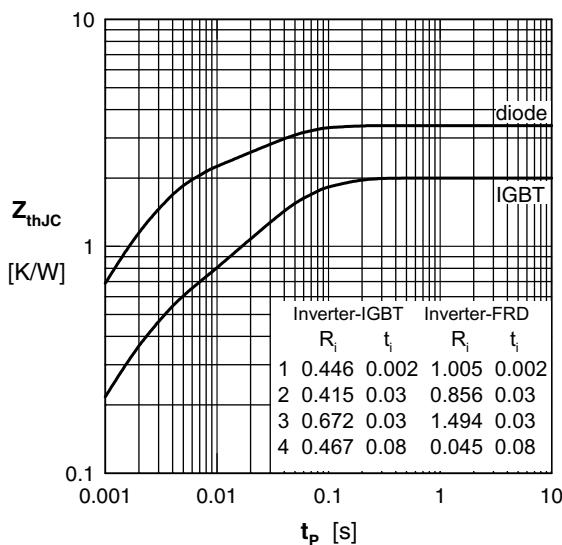


Fig. 15 Typ. transient thermal impedance

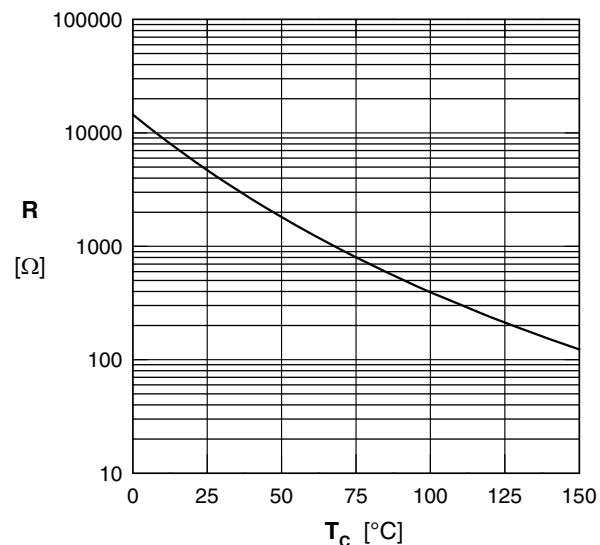


Fig. 16 Typ. NTC resistance vs. temperature